

Reports	VSC7420XJQ-01, VSC7421XJQ-01, VSC7422XJQ-01, VSC8522XJQ-01 Material Composition Declaration - Au Wire		1.0	04/13/2012		22 kB
Reports	VSC7420XJQ-02, VSC7420XJQ-04, VSC7421XJQ-02, VSC7421XJQ-04, VSC7422XJQ-02, VSC7422XJQ-04, VSC8522XJQ-02, VSC8522XJQ-04 Material Composition Declaration - Cu Wire		4.0	08/03/2015		19 kB
Reports	VSC7424XJG-01, VSC7425XJG-01, VSC7426XJG-01, VSC7427XJG-01, VSC7428XJG-01, VSC7429XJG-01, VSC8512XJG-01 Material Composition Declaration - Au Wire		1.0	04/13/2012		22 kB
Reports	First Level Product Qualification Report for VSC8522XJQ-02 - Amkpr P1		1.0	07/23/2015		67 kB
Reports	First Level Product Qualification Report for VSC8522XJQ-02 - Cu Wire		3.0	05/22/2014		73 kB
Reports	First Level Product Qualification Report for VSC8522XJQ-04 - Amkor K1		2.0	01/26/2016		88 kB
Reports	First Level Product Qualification Report for VSC8522XJQ-04 - Amkor P1		1.0	07/23/2015		67 kB
Reports	VSC8522 Latency Report		1.0	10/21/2010		83 kB
User Guide	SparX-III PoE/PoE+ Reference Design		1.0	08/02/2010		204 kB
White Paper	ENT-AN0106 SimpliPHY Architecture Advantages		1.1	06/16/2016		279 kB

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